

N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent RDS(ON) with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

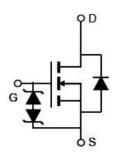
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

| V _{DS min@Tjmax} | 710 | V |
|---------------------------|-----|----|
| R _{DS(ON)TYP} | 300 | mΩ |
| ID | 11 | Α |
| Qg | 17 | nC |



Schematic diagram

Package Marking And Ordering Information

| Device | Device Package | Marking |
|------------|----------------|------------|
| NCE65N330I | TO-251-3L | NCE65N330I |



Table 1. Absolute Maximum Ratings (T_c=25℃)

| Parameter | Symbol | Value | Unit |
|--|-------------------------|---------|------|
| Drain-Source Voltage (VGS=0V) | VDS | 650 | V |
| Gate-Source Voltage (VDS=0V) AC (f>1 Hz) | Vgs | ±30 | V |
| Gate-Source Voltage (VDS=0V) DC | Vgs | ±20 | V |
| Continuous Drain Current at Tc=25°C | I _{D (DC)} | 11 | Α |
| Continuous Drain Current at Tc=100°C | I _{D (DC)} | 7.7 | Α |
| Pulsed drain current (Note 1) | I _{DM} (pluse) | 44 | А |
| Maximum Power Dissipation(Tc=25°C) | P _D | 107 | W |
| Derate above 25°C | | 0.71 | W/°C |
| Avalanche current ^(Note 2) | I _{AS} | 3 | Α |
| Drain Source voltage slope, V _{DS} ≤480 V, | dv/dt | 50 | V/ns |
| Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub> | dv/dt | 15 | V/ns |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55+175 | °C |

^{*} limited by maximum junction temperature



Table 2. Thermal Characteristic

| Parameter | Symbol | Value | Unit |
|---|-------------------|-------|-------|
| Thermal Resistance, Junction-to-Case (Maximum) | R _{thJC} | 1.4 | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R _{thJA} | 62 | °C /W |

 Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|--|---------------------|---|-----|-----|------|------|
| On/off states | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 650 | | | V |
| Zero Gate Voltage Drain Current(Tc=25℃) | I _{DSS} | V _{DS} =650V,V _{GS} =0V | | | 1 | μA |
| Zero Gate Voltage Drain Current(Tc=125℃) | I _{DSS} | V _{DS} =650V,V _{GS} =0V | | | 100 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | | | ±200 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =250μA | 3 | 3.5 | 4 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =5.5A | | 300 | 330 | mΩ |
| Dynamic Characteristics | | | | | • | |
| Input Capacitance | C _{lss} | V _{DS} =50V,V _{GS} =0V, | | 847 | | pF |
| Output Capacitance | Coss | V _{DS} =50V,V _{GS} =0V, F=1.0MHz | | 31 | | pF |
| Reverse Transfer Capacitance | C _{rss} | Γ-1.0IVIΠ2 | | 4 | | pF |
| Total Gate Charge | Qg | | | 17 | | nC |
| Gate-Source Charge | Q _{gs} | V_{DS} =480 V , I_{D} =5.5 A , | | 4.4 | | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} =10V | | 4.9 | | nC |
| Gate plateau voltage | Vgp | | | 5.4 | | V |
| Intrinsic gate resistance | Rg | f = 1 MHz open drain | | 18 | | Ω |
| Switching times | · | | | | | |
| Turn-on Delay Time | t _{d(on)} | | | 10 | | nS |
| Turn-on Rise Time | tr | V_{DD} =480 V , I_{D} =5.5 A , | | 7 | | nS |
| Turn-Off Delay Time | t _{d(off)} | $R_G=1.7\Omega, V_{GS}=10V$ | | 55 | | nS |
| Turn-Off Fall Time | t _f | | | 8 | | nS |
| Source- Drain Diode Characteristics | | | | | | |
| Source-drain current(Body Diode) | I _{SD} | T -25°C | | | 11 | Α |
| Pulsed Source-drain current(Body Diode) | I _{SDM} | T _C =25°C | | | 44 | Α |
| Forward On Voltage | V _{SD} | Tj=25°C,I _{SD} =11A,V _{GS} =0V | | 0.9 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | T:=25°C ! =5.5A | | 200 | | nS |
| Reverse Recovery Charge | Qrr | Tj=25°C,I _F =5.5A, | | 1.6 | | uC |
| Peak Reverse Recovery Current | I _{rrm} | di/dt=100A/μs | | 16 | | Α |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

^{2.} Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V, RG=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

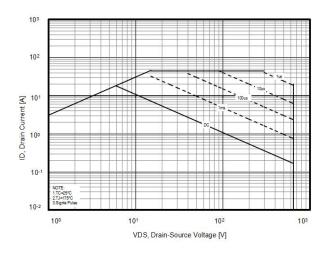


Figure 3. Transfer characteristics

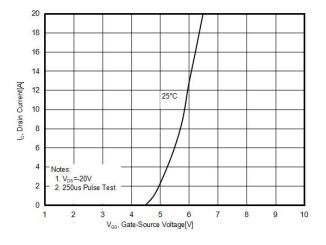


Figure 5. R_{DS(ON)} vs Junction Temperature

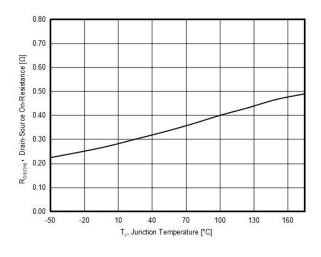


Figure 2. Capacitance

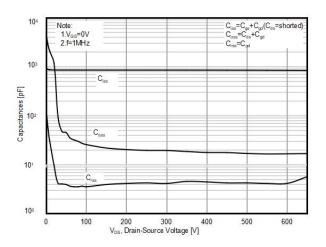


Figure 4. Output characteristics

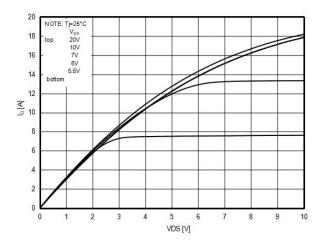


Figure 6. BV_{DSS} vs Junction Temperature

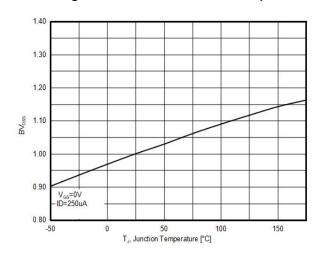




Figure 7. Maximum ID vs Junction Temperature

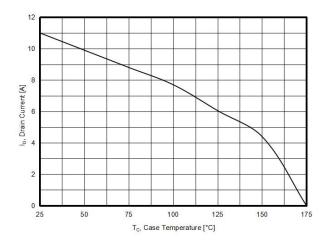


Figure 9. Static drain-source on resistance

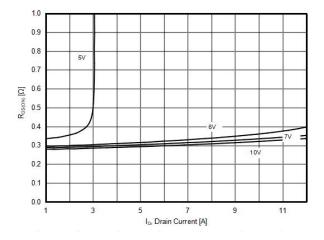


Figure 8. Gate charge waveforms

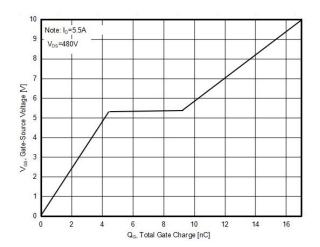
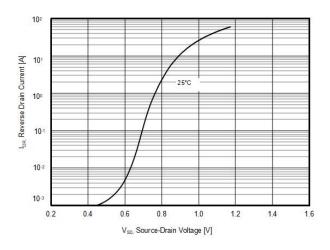


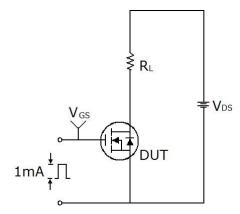
Figure 10. Source-Drain Diode Forward Voltag

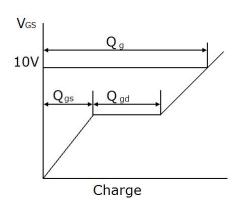




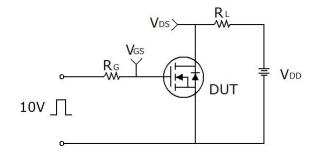
Test circuit

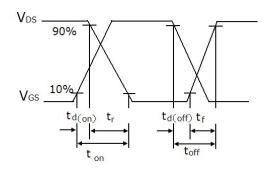
1) Gate charge test circuit & Waveform



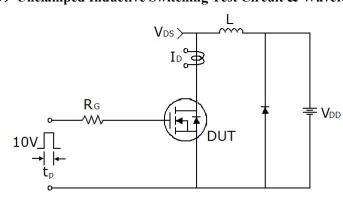


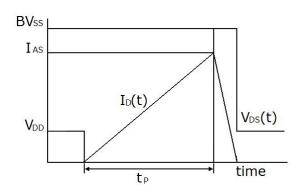
2) Switch Time Test Circuit:





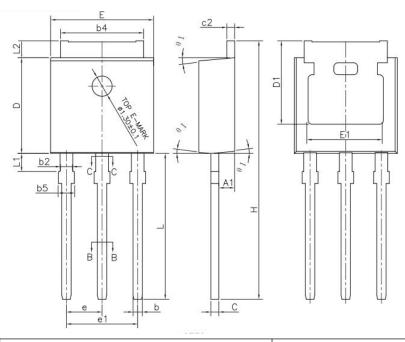
3) Unclamped Inductive Switching Test Circuit & Waveforms







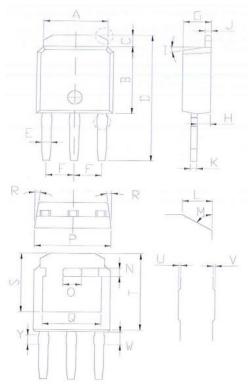
TO-251-3L-P Package Information



| Symbol | Dimensions I | n Millimeters | Dimensions In Inches | | |
|--------|--------------|---------------|----------------------|-------|--|
| Cymbol | Min. | Max. | Min. | Max. | |
| Α | 2.20 | 2.35 | 0.087 | 0.093 | |
| A1 | 0.90 | 1.10 | 0.035 | 0.043 | |
| b | 0.56 | 0.69 | 0.022 | 0.027 | |
| b1 | 0.55 | 0.65 | 0.022 | 0.026 | |
| b2 | 0.77 | 0.90 | 0.030 | 0.035 | |
| b3 | 0.76 | 0.86 | 0.030 | 0.034 | |
| b4 | 5.23 | 5.43 | 0.206 | 0.214 | |
| b5 | | 1.05 | | 0.041 | |
| С | 0.46 | 0.59 | 0.018 | 0.023 | |
| c1 | 0.45 | 0.55 | 0.018 | 0.022 | |
| c2 | 0.46 | 0.59 | 0.018 | 0.023 | |
| D | 6.00 | 6.20 | 0.236 | 0.244 | |
| D1 | 5.20 | | 0.205 | | |
| E | 6.50 | 6.70 | 0.256 | 0.264 | |
| E1 | 4.60 | 5.00 | 0.181 | 0.197 | |
| е | 2.24 | 2.34 | 0.088 | 0.092 | |
| e1 | 4.47 | 4.67 | 0.176 | 0.184 | |
| Н | 16.18 | 16.78 | 0.637 | 0.661 | |
| L | 9.00 | 9.60 | 0.354 | 0.378 | |
| L1 | 0.95 | 1.35 | 0.037 | 0.053 | |
| L2 | 0.90 | 1.25 | 0.035 | 0.049 | |



TO-251-3L-L Package Information



| Ob. al | Dimensions | In Millimeters | Dimensions In Inches | | |
|--------|------------|----------------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| А | 5.04 | 5.64 | 0.198 | 0.222 | |
| В | 5.70 | 6.30 | 0.224 | 0.248 | |
| С | 0.75 | 1.35 | 0.030 | 0.053 | |
| D | 11.01 | 11.61 | 0.433 | 0.457 | |
| Е | 0.61 | 0.91 | 0.024 | 0.036 | |
| F | 2.13 | 2.43 | 0.084 | 0.096 | |
| G | 2.00 | 2.60 | 0.079 | 0.102 | |
| Н | 0.76 | 1.36 | 0.030 | 0.054 | |
| J | 0.36 | 0.66 | 0.014 | 0.026 | |
| K | 0.37 | 0.67 | 0.015 | 0.026 | |
| L | 0.50 | 1.10 | 0.020 | 0.043 | |
| N | 0.45 | 1.05 | 0.018 | 0.041 | |
| 0 | 1.50 | 2.10 | 0.059 | 0.083 | |
| Р | 6.30 | 6.90 | 0.248 | 0.272 | |
| Q | 4.55 | 5.15 | 0.179 | 0.203 | |
| S | 5.00 | 5.60 | 0.197 | 0.220 | |
| Т | 6.60 | 7.20 | 0.260 | 0.283 | |
| W | 0.90 | 1.40 | 0.035 | 0.055 | |
| Y | 0.60 | 1.10 | 0.024 | 0.043 | |



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